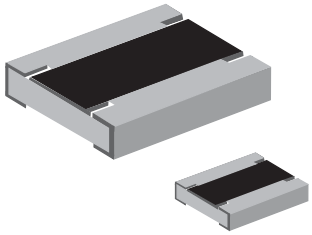
Long Side Termination Thick Film Chip Resistors



FEATURES

- Enhanced power rating
- Long side terminations
- Pure tin solder contacts on Ni barrier layer, provides compatibility with lead (Pb)-free and lead containing soldering processes
- Compliant to RoHS Directive 2002/95/EC
- Halogen-free according to IEC 61249-2-21 definition
- AEC-Q200 qualified

RoHS COMPLIANT HALOGEN FREE

STANDARD ELECTRICAL SPECIFICATIONS

MODEL	SIZE		RATED DISSIPATION P_{70} W	LIMITING ELEMENT VOLTAGE $U_{max.}$ AC/DC V	TEMPERATURE COEFFICIENT ppm/K	TOLERANCE %	RESISTANCE RANGE Ω	SERIES
	INCH	METRIC						
RCL0612 e3	0612	RR 1632M	0.5	75	± 100	± 1	1R0 to 1M	E24; E96
					± 200	± 5		E24
RCL1218 e3	1218	RR 3246M	1.0	200	± 100	± 1	1R0 to 2.2M	E24; E96
					± 200	± 5		E24
RCL1225 e3	1225	RR 3263M	2.0 (1)	200	± 100	± 1	1R0 to 1M	E24; E96
					± 200	± 5		E24

Notes

- These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime.
- Marking: See datasheet “Surface Mount Resistor Marking” (document number 20020).
- Power rating depends on the max. temperature at the solder point, the component placement density and the substrate material.

(1) Specified power rating requires dedicated mounting conditions to achieve the required thermal resistance.

TECHNICAL SPECIFICATIONS

DESCRIPTION	UNIT	RCL0612	RCL1218	RCL1225
Rated Dissipation P_{70} (2)	W	0.5	1.0	2.0 (3)
Limiting Element Voltage $U_{max.}$ AC/DC	V	75	200	200
Insulation Voltage U_{ins} (1 min)	V	> 100	> 300	> 300
Insulation Resistance	Ω	$> 10^9$		
Category Temperature Range	°C	- 55 to + 155		
Weight	mg	11	29.5	55

Notes

(2) The power dissipation on the resistors generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature of 155 °C is not exceeded.

(3) Specified power rating requires dedicated mounting conditions to achieve the required thermal resistance.

PART NUMBER AND PRODUCT DESCRIPTION

PART NUMBER: RCL061210K0FKEA

R	C	L	0	6	1	2	1	0	K	0	F	K	E	A	0	0

MODEL/SIZE	RESISTANCE	TOLERANCE	TCR	PACKAGING	SPECIAL
RCL0612 **RCL1218** **RCL1225**	**R** = Decimal **K** = Thousand **M** = Million **0000** = Jumper	**F** = ± 1 % **J** = ± 5 % **Z** = Jumper	**K** = ± 100 ppm/K **N** = ± 200 ppm/K **0** = Jumper	**EA** **EB** **EC** **EK** **EG**	Up to 2 digits **00** = Standard

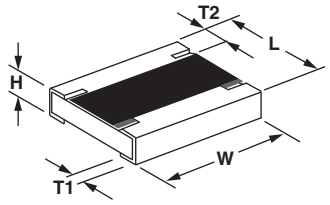
PRODUCT DESCRIPTION: RCL0612 100 10K 1 % ET1 e3

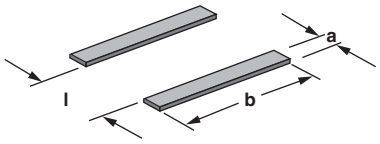
RCL0612	100	10K	1 %	ET1	e3
MODEL	TCR	RESISTANCE	TOLERANCE	PACKAGING	LEAD (Pb)-FREE
RCL0612 **RCL1218** **RCL1225**	± **100** ppm/K ± **200** ppm/K	**10R** = 10 Ω **10K** = 10 kΩ **1M** = 1 MΩ **0R0** = Jumper	± **1 %** ± **5 %**	**ET1** **ET5** **ET6** **ET9** **E67**	**e3** = Pure tin termination finish

PACKAGING

MODEL	UNIT	PAPER TAPE ON REEL ACC. TO IEC 60286-3, TYPE I			BLISTER TAPE ON REEL ACC. TO IEC 60286-3, TYPE II		
		QUANTITY	PART NUMBER	PRODUCT DESC.	QUANTITY	PART NUMBER	PRODUCT DESC.
RCL0612	180 mm/7"	5000	EA	ET1			
	285 mm/11.25"	10 000	EB	ET5			
	330 mm/13"	20 000	EC	ET6			
RCL1218	180 mm/7"				4000	EK	ET9
RCL1225	180 mm/7"				2000	EG	E67

DIMENSIONS in millimeters

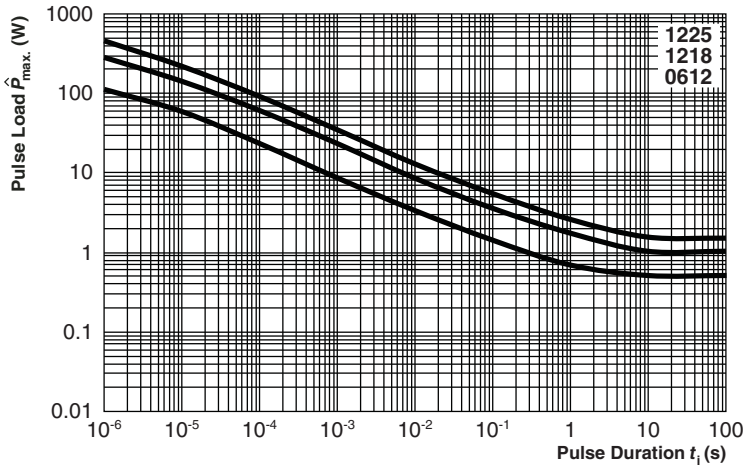




SIZE		DIMENSIONS					SOLDER PAD DIMENSIONS					
							REFLOW SOLDERING			WAVE SOLDERING		
INCH	METRIC	L	W	H	T1	T2	a	b	l	a	b	l
0612	1632	1.6 ± 0.2	3.2 ± 0.2	0.55 ± 0.1	0.35 ± 0.15	0.25 ± 0.15	0.6	3.2	1.0	1.1	3.2	1.0
1218	3246	3.2 $^{+0.10}_{-0.20}$	4.6 ± 0.15	0.55 ± 0.05	0.45 ± 0.2	0.4 ± 0.2	1.1	4.9	1.9	1.25	4.8	1.9
1225	3263	3.2 ± 0.2	6.3 ± 0.2	0.75 ± 0.15	0.8 ± 0.2	0.4 ± 0.2	1.9	7.6	1.2	1.9	7.6	1.2

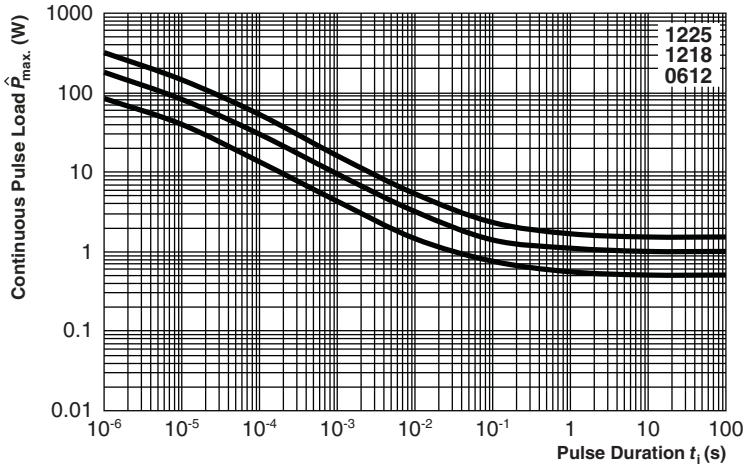
FUNCTIONAL PERFORMANCE

Single Pulse



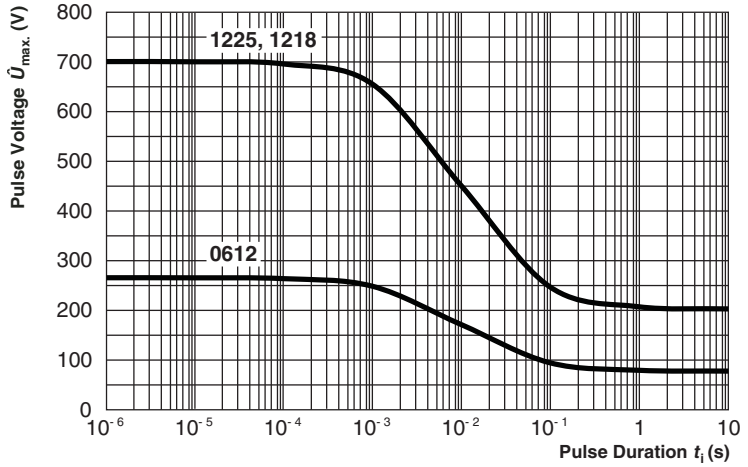
Maximum pulse load, single pulse; applicable if $\bar{P} \rightarrow 0$ and n < 1000 and $\hat{U} \leq \hat{U}_{max.}$; for permissible resistance change equivalent to 8000 h operation

Continuous Pulse



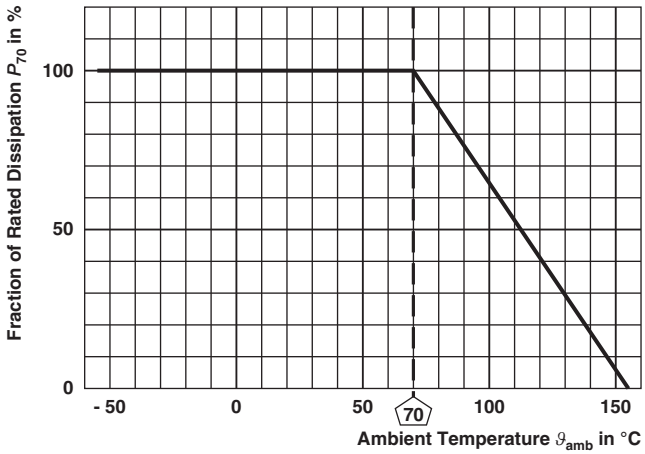
Maximum pulse load, continuous pulses; applicable if $\bar{P} \leq P\ (\vartheta_{amb})$ and $\hat{U} \leq \hat{U}_{max.}$; for permissible resistance change equivalent to 8000 h operation

Pulse Voltage



Maximum pulse voltage, single and continuous pulses; applicable if $\hat{P} \leq \hat{P}_{max.}$; for permissible resistance change equivalent to 8000 h operation

Derating



TEST PROCEDURES AND REQUIREMENTS					
EN 60115-1 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR)	
				STABILITY CLASS 2 OR BETTER	
			Stability for product types:	1 Ω to 2.2 MΩ	
			RCL e3		
4.5	-	Resistance	-	± 1 %	± 5 %
4.7	-	Voltage proof	U = 1.4 x U_{ins}; 60 s	No flashover or breakdown	
4.13	-	Short time overload	$U = 2.5 \times \sqrt{P_{70} \times R}$ ≤ 2 x $U_{max.}$; Duration acc. to style	± (0.25 % R + 0.05 Ω)	± (0.5 % R + 0.05 Ω)
4.17.2	58 (Td)	Solderability	Solder bath method; Sn60Pb40 non activated flux; (235 ± 5) °C (2 ± 0.2) s	Good tinning (≥ 95 % covered); no visible damage	
			Solder bath method; Sn96.5Ag3Cu0.5 non-activated flux; (245 ± 5) °C (3 ± 0.3) s	Good tinning (≥ 95 % covered); no visible damage	
4.8.4.2	-	Temperature coefficient	(20/- 55/20) °C and (20/125/20) °C	± 100 ppm/K	± 200 ppm/K
4.32	21 (Uu_3)	Shear (adhesion)	45N	No visible damage	
4.33	21 (Uu_1)	Substrate bending	Depth 2 mm; 3 times	No visible damage, no open circuit in bent position ± (0.25 % R + 0.05 Ω)	
4.19	14 (Na)	Rapid change of temperature	30 min at - 55 °C; 30 min at 125 °C		
			5 cycles	± (0.25 % R + 0.05 Ω)	± (0.5 % R + 0.05 Ω)
			1000 cycles	± (1 % R + 0.05 Ω)	± (1 % R + 0.05 Ω)

TEST PROCEDURES AND REQUIREMENTS

EN 60115-1 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR)	
				STABILITY CLASS 2 OR BETTER	
			Stability for product types: RCL e3	1 Ω to 2.2 MΩ	
4.23	-	Climatic sequence:	-		
4.23.2	2 (Ba)	Dry heat	125 °C; 16 h		
4.23.3	30 (Db)	Damp heat, cyclic	55 °C; ≥ 90 % RH; 24 h; 1 cycle		
4.23.4	1 (Aa)	Cold	- 55 °C; 2 h	± (1 % R + 0.05 Ω)	± (2 % R + 0.1 Ω)
4.23.5	13 (M)	Low air pressure	1 kPa; (25 ± 10) °C; 1 h		
4.23.6	30 (Db)	Damp heat, cyclic	55 °C; ≥ 90 % RH; 24 h; 5 cycles		
4.23.7	-	DC load	$U = \sqrt{P_{70} \times R}$		
4.25.1	-	Endurance at 70 °C	$U = \sqrt{P_{70} \times R} \leq U_{max.}$; 1.5 h on; 0.5 h off; 70 °C; 1000 h	± (0.5 % R + 0.05 Ω)	± (2 % R + 0.1 Ω)
			70 °C; 8000 h	± (1 % R + 0.05 Ω)	± (4 % R + 0.1 Ω)
4.18.2	58 (Td)	Resistance to soldering heat	Solder bath method (260 ± 5) °C; (10 ± 1) s	± (0.25 % R + 0.05 Ω)	± (0.5 % R + 0.05 Ω)
4.35	-	Flamability, needle flame test	IEC 60695-11-5; 10 s	No burning after 30 s	
4.24	78 (Cab)	Damp heat, steady state	(40 ± 2) °C; (93 ± 3) % RH; 56 days	± (1 % R + 0.05 Ω)	
4.25.3	-	Endurance at upper category temperature	155 °C, 1000 h	± (1 % R + 0.05 Ω)	± (2 % R + 0.1 Ω)
4.40	-	Electrostatic discharge (Human Body Model)	IEC 61340-3-1 3 pos. + 3 neg. discharges; ESD voltage: 1000 V	± (1 % R + 0.05 Ω)	
4.29	45 (XA)	Component solvent resistance	Isopropyl alcohol; 50 °C; method 2	No visible damage	
4.30	45 (XA)	Solvent resistance of marking	Isopropyl alcohol; 50 °C; method 1, toothbrush	Marking legible, no visible damage	
4.22	6 (Fc)	Vibration, endurance by sweeping	f = 10 Hz to 2000 Hz; x, y, z ≤ 1.5 mm; A ≤ 200 m/s²; 10 sweeps per axis	± (0.25 % R + 0.05 Ω)	± (0.5 % R + 0.05 Ω)
4.37	-	Periodic electric overload	$U = \sqrt{15 \times P_{70} \times R} \leq 2 \times U_{max.}$; 0.1 s on; 2.5 s off; 1000 cycles	± (1 % R + 0.05 Ω)	
4.27	-	Single pulse high voltage overload, 10 µs/700 µs	$\hat{U} = 10 \times \sqrt{P_{70} \times R} \leq 2 \times U_{max.}$; 10 pulses	± (1 % R + 0.05 Ω)	

All tests are carried out in accordance with the following specifications:

- EN 60115-1, generic specification
- EN 140400, sectional specification
- EN 140401-802, detail specification
- IEC 60068-2-x environmental test procedures

Packaging of components is done in paper or blister tapes according to IEC 60286-3

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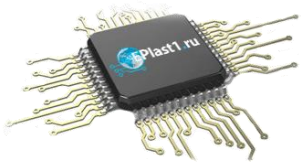
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)
Факс: 8 (812) 320-02-42
Электронная почта: org@eplast1.ru
Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.